LNJ812R8DRA

Surface Mounting Chip LED

TSS Type

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol Rating		Unit	
Power dissipation	P_{D}	50	mW	
Forward current	I_{F}	20	mA	
Pulse forward current *	I_{FP}	60	mA	
Reverse voltage	V _R	3	V	
Operating ambient temperature	T _{opr}	-30 to +85	°C	
Storage temperature	T _{stg}	-40 to +100	°C	

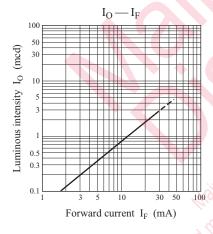
Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

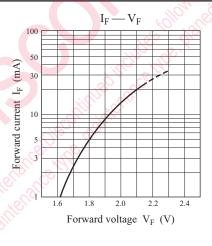
■ Lighting Color

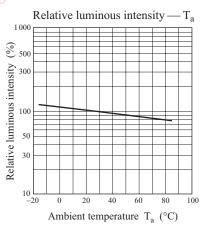
Orange

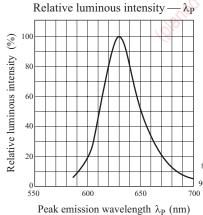
■ Electro-Optical Characteristics $T_a = 25$ °C

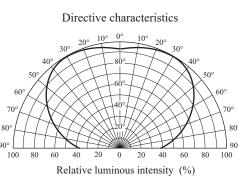
Parameter	Symbol		Conditions	Min	Тур	Max	Unit
Luminous intensity	I _O	$I_F = 10 \text{ mA}$		0.4	1.0	2	med
Reverse current	I_R	$V_R = 3 V$		(10,1)	7160,	10	μΑ
Forward voltage	V _F	$I_F = 10 \text{ mA}$	X	(00) (00)	1.93	2.6	V
Peak emission wavelength	λ_{P}	$I_F = 10 \text{ mA}$, our	dillo	630		nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$	91, Qni	30,	40		nm

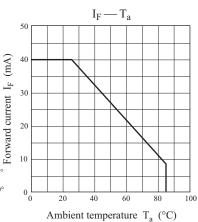








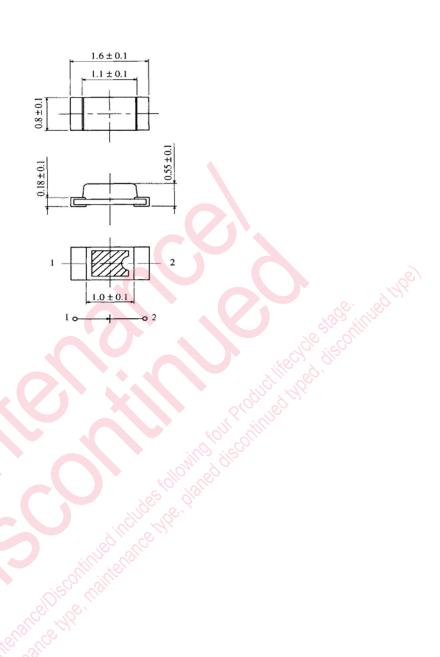




LNJ812R8DRA Panasonic

■ Package (Unit: mm)

KLTFTN2K1200



- Pin name
 - 1: Anode
 - 2: Cathode

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